

Metal Additive Manufacturing Challenges & Opportunities

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Additive Manufacturing The Third Industrial Revolution







Additive Manufacturing The Future: Great Expectations. Will It Deliver?



Metal Additive Manufacturing Different Technologies

Description Powder bed/layer SLS, SLM, DMLS, EBSM

Selective Laser Melting (SLM) Selective Laser Sintering (SLS) Direct Metal Laser Sintering (DMLS) Electron Beam Selective Melting (EBSM/Arcam)

Direct deposition LENS, DLD, DLF, Cladding WAAM, DLD, EBFFF

Laser Engineered Net-Shaping (LENS) Direct Laser Deposition/Fabrication (DLD/DLF) Wire Arc Additive Manufacturing (WAAM) Electron Beam free-form fabrication (EBFFF)







Additive Manufacturing Distribution of Metal & Plastic Technologies (EU)





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Challenges Facing Metal AM Technology Barriers

- Component costs are too high when compared with established manufacturing technology (e.g. casting, forging).
- Deposition rates of processes are too slow, making a weak business case (depreciation vs. build rates).
- AM machines are expensive, not autonomous, have size constraints.
- Powders and resins are too expensive for part mass production and in the case of metals not tailored/designed to AM (80% of research focuses on Ti-64, IN718, & AlSiMg Alloys).
- □ **Insufficient/changing data** to construct business models.
- □ Product **quality is inconsistent** between batches/machines.
- □ Lack of in-line **monitoring/control**.
- Post-processing (e.g. HIPping, surface finishing, or machining) is always required.



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Challenges Facing Metal AM In Other Words*...





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Deciding on AM Research Strategy Weighing the Risks and Opportunities

Companies have to weigh the risks and opportunities in AM research. The decision can be one of the following:

1. Do nothing; wait and see (e.g. Russia).

- +: Investment in metal AM involves a high risk in a technology that has not yet provided a noticeable impact.
- -: The risk of missing an opportunity!
- 2. Develop an **individual long-term strategy (GE)**
 - +: Protect any potential IP, develop a strategy that matches the company's products.
 - -: Resources, expensive!
- 3. Develop strategy involving academic & industrial (supplychain) partners (Rolls-Royce, Safran):
 - +: Sharing the cost, effort, knowledge, and resources.
 - : The risk of not securing the IP.





AM Research Strategies 1-The One-Shot Approach

- □ Identify a component;
- acquire the raw material;
- □ use the machine manufacturer approved parameters;
- □ <u>standard</u> post processing (e.g. HIPping)
- perform component testing (<u>in-service</u> conditions, static/ dynamic) and validation (micro CT, mechanical testing); FE simulations.
 - +: Cost-effective, rapid TRL/MCRL qualification, marketing/PR advantage (using a trendy technology)
 - -: Requires approval following any change (component design, supplier, etc...), not standardised/transferable to other components, redundancy.





AM Research Strategies Thales Alenia*: One-Shot Approach (Satellites/Low batch)





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AM Research Strategies Airbus UK*: One Shot Approach (Satellites/Low batch)





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AM Research Strategies 2-Multi-Phase Approach (MTU Aero*)

Phase 1: Tooling & Development Hardware



Manufacturing of Tooling, Development Hardware

Phase 2: Substitution



Cost effective Manufacturing of raw Parts Substitution of Castings "Learner" for SLM Process Qualifying

Phase 3: New AM Design



Manufacturing of functional Structures to reduce Weight and Cost



© AMPLab 2015 *J. Bamberg, K.H. Dusel, W. Satzger , 2014



AM Research Strategies 3-Standard Qualification Approach

- A comprehensive approach that researches <u>all the process</u> <u>factors</u> (e.g. process parameters, platforms, powder quality & recyclability, post-processing, mechanical properties, FE-simulations/process modelling, etc...
 - +: Better understanding of the process, applicability to transfer to various components, standardised.
 - -: Expensive, time-consuming.





AM Research Strategies AvioGE Standard Qualification (y-TiAl Blade)





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AM Research Strategy Airbus Standard Qualification (Ti-64)



AM Research Strategies Airbus (Business Advantage of Standard Qualification)







AM Research Strategies Standard Qualification AM Products



GE Aviation Leap Engine Nozzle 10⁵ parts required by 2020 3% wt. reduction 2.5 x endurance Cost (mass production)?!



Rolls-Royce Trent XWB OGV

Vanes made by Arcam + Welded Test flight in 2015 Properties? Weight reduction? Cost (mass production)?!



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Metal Additive Manufacturing Research Challenges Investigated by UoB/AMPLab

- Impact of powder feedstock (consistency, quality, performance, repeatability, and security) on properties.
- Process modelling using computationally non-CPU intensive codes.
- Non-destructive evaluation, in-situ monitoring, 3D scanning, Micro CT.
- Residual stress: measurement, management and control.
- □ Microstructure-Property control (e.g. property optimisation).
- □ Surface finishing and post-processing (e.g. HIPping).



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Addressing AM Research Challenges Powder Quality & Impact on Properties

- Significant disparities can exist in powder morphology, flowability, apparent/tap density, chemistry (N,O,C), etc....
- Repeatability/consistency/recyclability of powder are concerns.
- Limited data is available on the impact of powder characteristics on the product performance.





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Addressing AM Research Challenges FE Modelling of Residual Stress & Temperature

- A useful tool to predict the temperatures, microstructural development, residual stress, and properties.
- The challenge is to create models that produce 'reasonable' predictions, with limited 'fudge factors' (fitting parameters), and low computational time.



Addressing AM Research Challanges An Holistic Approach to Product Qualification

□ **Aim:** To establish SLM processing route for aerospace components from the high temperature Ni-superalloy CM247LC

Main Findings:

Understand the influence of the process parameters, and post-processing heat treatments, to minimise the defects, improve microstructure and maximise mechanical properties.





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Additive Manufacturing Addressing the Challenges

- Defect formation, characterisation & mitigation
- Post-processing (using HIPping)
- Tooling development using AM
- Micro and macro modelling of A
- Multi-functional AM
- Microstructural control
- □ Large scale deposition





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Additive Manufacturing Key Technology/Materials challenges

- □ Alloy development for ALM.
- Physics-based tool path (heat source) optimisation.
- □ Laser-powder interaction: physics and thermodynamics.
- Difficult-to-ALM materials: tungsten, single crystal Nisuperalloys, refractories, Al-alloys, gum metal, SMAs, silicides, composites, Ni-superalloys, γ-TiAl, etc...
- □ Novel applications: sensors embedding, composites, etc...





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Additive Manufacturing Research Roadmap





Summary & Conclusions





Conclusions Author's View

- There are several models for a research strategy development in Additive Manufacturing.
- The MTU's 3-phase strategy provides a balanced approach for AM technology adoption.
- The standard qualification approach develops knowledge & standards that are applicable to various components in the business, provided that the business need exists.
- The one-shot approach may help the company score immediate business/marketing image target.
- Technology challenges can only be addressed via a balanced modelling & experimentation approach.



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Technology Success

"For a successful technology, *reality* must take precedence over *public relations*, for nature cannot be fooled."

Richard Feynman, 1986





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Collaborations & Funding 2011-2015



References

□ <u>Moataz Attallah</u>



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Thank You Questions?



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